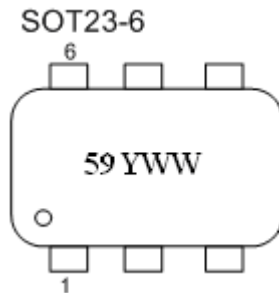
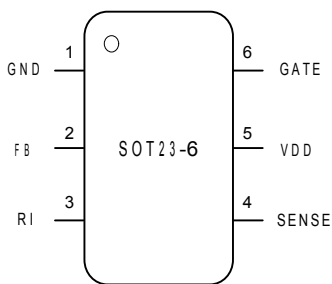
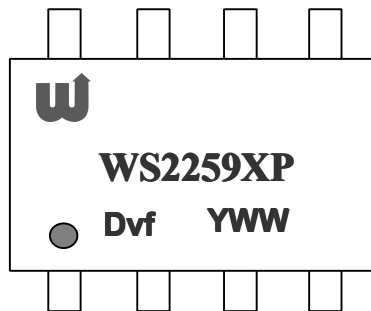
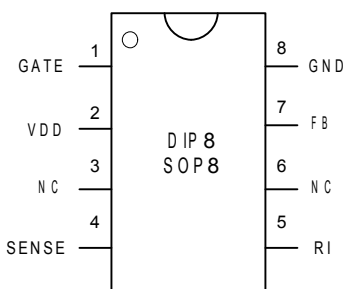


Pin Definition and Device Marking

WS2259 is offered in SOT23-6, SOP-8 and DIP-8 packages, as shown below:



59: WS2259
Y: Year Code (1:2011; 2:2012.....)
WW: Week Code (1-52)



X: D = DIP8 , S = SOP8
P: P = Pb-free package
D: 芯片代码
V: 内部版本号 (可选 1-9)
f: 工厂代码
Y: Year Code (1:2011; 2:2012.....)
WW: Week Code (1-52)

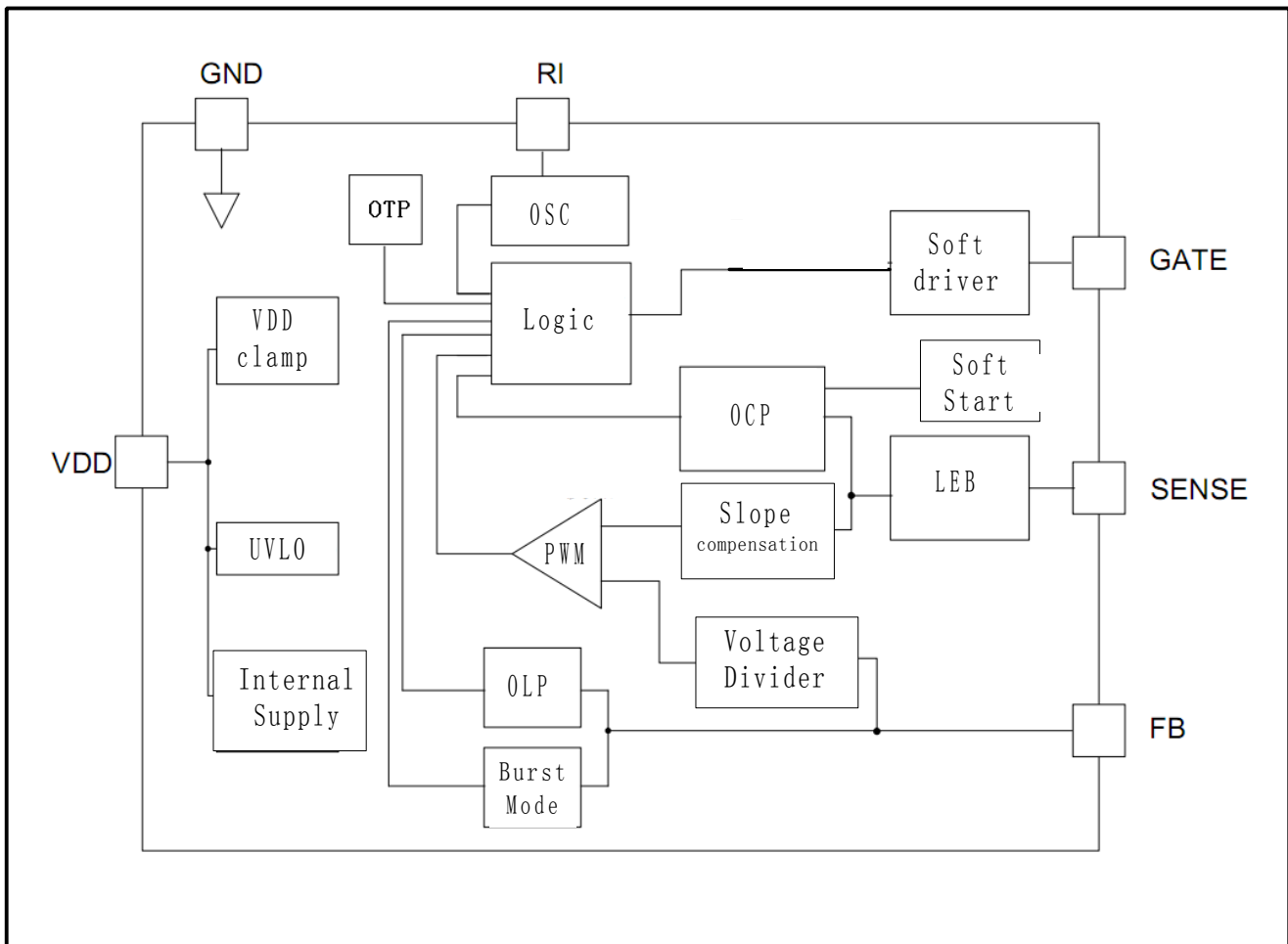
Ordering Information

| Package | IC Marking Information | Purchasing Device Name |
|------------------------|------------------------|------------------------|
| 8-Pin DIP8, Pb-free | WS2259DP | WS2259DP |
| 8-Pin SOP8, Pb-free | WS2259SP | WS2259SP |
| 6-Pin SOT23-6, Pb-free | 59XXX | WS2259YP (SOT23-6) |

Pin Function Description

| Pin Name | Pin No. DIP8/SOT23 | Pin Type | Function Description |
|----------|--------------------|--------------------|---|
| GATE | 1 / 6 | Output | Totem-pole gate drive output for the power MOSFET |
| VDD | 2 / 5 | Power | Power Supply |
| NC | 3 | Floating | Floating |
| SENSE | 4 / 4 | Current Monitoring | Current sense input. |
| RI | 5 / 3 | Frequency Setting | Internal oscillator frequency setting pin. A resistor which is connected between RI and GND sets the PWM frequency |
| NC | 6 | Floating | Floating |
| FB | 7 / 2 | Feedback Input | Feedback input pin. The PWM duty cycle is determined by voltage into this pin and the current-sense signal at Pin 4 |
| GND | 8 / 1 | Ground | Ground |

Block Diagram



Recommended Operating Condition

| Symbol | Parameter | Value | Unit |
|----------------|-----------------------|--------|------|
| VDD | VDD Supply Voltage | 10~30 | V |
| RI | RI Resistor | 100 | Kohm |
| T _A | Operating temperature | -20~85 | °C |

Absolute Maximum Ratings (Note 1)

| Symbol | Parameter | Value | Unit |
|--------------------|--------------------------------|---------|------|
| VDD | DC Power Supply | 30 | V |
| V _{FB} | FB input voltage | -0.3~7 | V |
| V _{SENSE} | SENSE input voltage | -0.3~7 | V |
| V _{RI} | RI input voltage | -0.3~7 | V |
| T _J | Operation Junction Temperature | -20~150 | °C |
| T _{STG} | Storage Temperature | -40~150 | °C |
| V _{CV} | Vcc Clamp Voltage | 31 | V |
| I _{CC} | Vcc Clamp Continuous Current | 10 | mA |

Note 1: Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, functional operation of the device at these or any other conditions beyond those indicated in the Recommended Operating Conditions section are not implied. Exposure to absolute maximum-rated conditions for extended periods may affect device reliability.

ESD Information

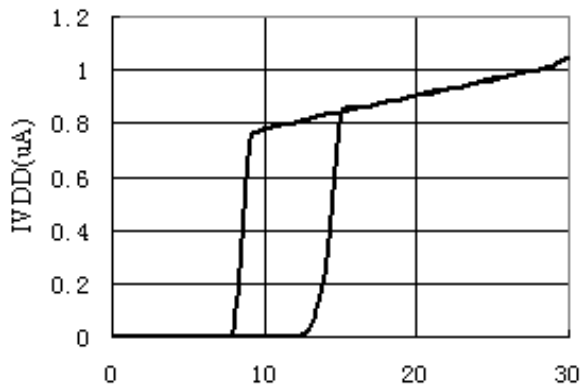
| Symbol | Parameter | Value | Unit |
|----------------------|------------------------------|-------|------|
| V _{ESD-HBM} | Human body model on all pins | 3 | KV |
| V _{ESD-MM} | Machine model on all pins | 300 | V |

Electrical Characteristics ($T_A=25^{\circ}\text{C}$, $V_{CC}=16\text{V}$, if not otherwise noted)

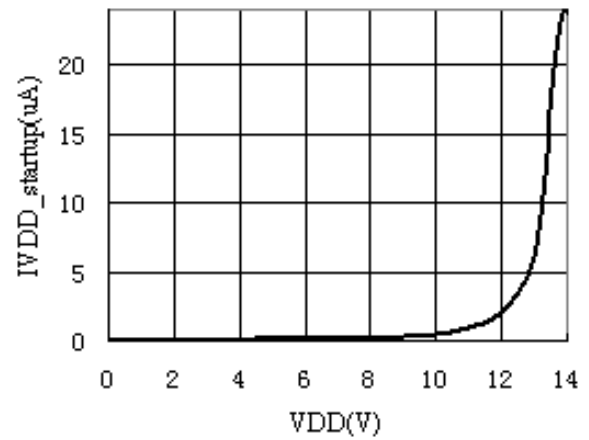
| Supply Voltage (VDD) | | | | | | |
|--|-----------------------|---|------|------|------|------|
| Parameter | Symbol | Test condition | Min | Typ | Max | Unit |
| Operation voltage | VDD_OP | | | | 30 | V |
| Turn on threshold Voltage | UVLO_ON | | 6.8 | 7.5 | 8 | V |
| Turn-off threshold Voltage | UVLO_OFF | | 13.5 | 14.5 | 15.5 | V |
| Start up current | I_VDD_ST | VDD=13V,RI=100K | | 4 | 10 | uA |
| Operation Current | I_VDD_OP | VDD=16V,RI=100K,V _{FB} =3V GATE with 1nF to GND | | 1.7 | 2.3 | mA |
| | VDD_OVP | | | 29 | | V |
| VDD Zener Clamp Voltage | VDD_Clamp | IVDD=10mA | | 31 | | V |
| Feedback Input Section | | | | | | |
| V _{FB} Open Loop Voltage | V _{FB_Open} | VDD=16V,FB open, | 5.4 | 5.9 | 6.4 | V |
| FB Pin Short Current | I _{FB_Short} | FB Shorted to GND | 0.3 | 0.45 | 0.6 | mA |
| Power limiting FB Threshold | V _{TH_PL} | VDD=16V, RI=100K | 3.2 | 3.65 | 4.0 | V |
| Power limiting Debounce | T _{D_PL} | VDD=16V,FB open,RI=100KΩ | 48 | 60 | 72 | ms |
| Input Impedance | Z _{FB_IN} | VDD=16V,FB=2V/3V,CS open | 11.5 | 14.5 | 18 | kΩ |
| Maximum duty cycle | Max_Duty | VDD=16V,FB open, CS=0,RI=100KΩ | 72 | 77 | 82 | % |
| Current Sense Section | | | | | | |
| Leading edge Blanking Time | TLEB | | | 330 | | ns |
| OCP control delay | T _{D_OC} | GATE with 1nF to GND | | 70 | | ns |
| OCP threshold | T _{TH_OC} | FB=3.2V | 0.68 | 0.78 | 0.78 | V |
| Oscillator Section | | | | | | |
| Frequency | Fosc | VDD=16V,RI=100K,,FB=3.2V | 60 | 65 | 70 | khz |
| | Jitter period | For 65K | | 4 | | ms |
| | Jitter range | | | ±5 | | % |
| Burst mode frequency | Fosc_BM | VDD=9.5V,RI=100K, FB=1V | | 22 | | khz |
| Frequency variation versus temp. Deviation | Δf_temp | TEMP = -20 to 85°C | | 5 | | % |
| Frequency variation versus VDD | Δf_VDD | VDD = 12 to 25V | | 5 | | % |
| RI Section | | | | | | |
| RI voltage | V _{RI} | VDD=16V,RI=100KΩ,CS=1V | 1.94 | 2 | 2.06 | V |
| Thermal protection | | | | | | |
| Thermal shutdown temperature | T_shutdown | | | 150 | | °C |
| GATE Output Section | | | | | | |
| Output voltage Low | VOL | VDD = 16V, I _o = -20mA | | | 0.8 | V |
| Output voltage high | VOH | VDD = 16V, I _o = 20mA | 9 | | | V |
| Output clamp voltage | VClamp | VDD = 20V | 11 | 13 | 14.5 | V |
| Rising time | Tr | VDD = 16V, GATE with 1nF to GND | | 250 | | ns |
| Falling time | Tf | VDD = 16V, GATE with 1nF to GND | | 75 | | ns |

Typical Operating Characteristics

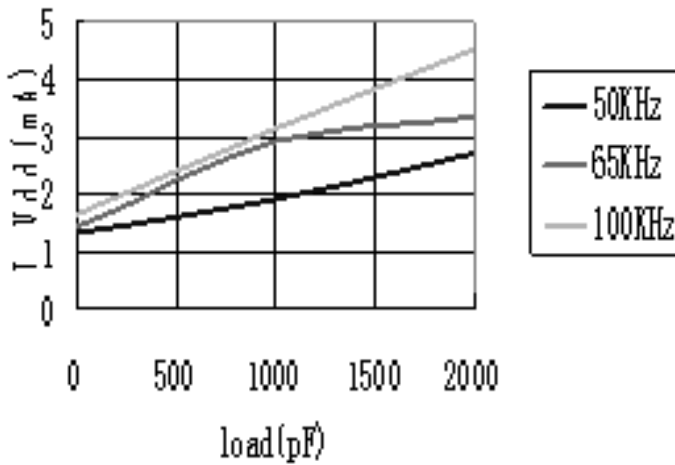
IVDD vs VDD



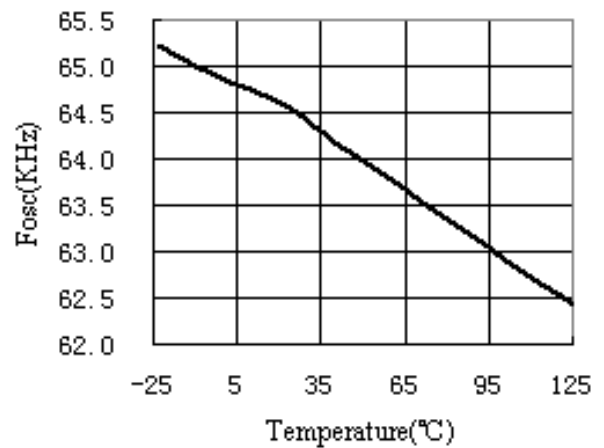
IVDD_startup vs VDD



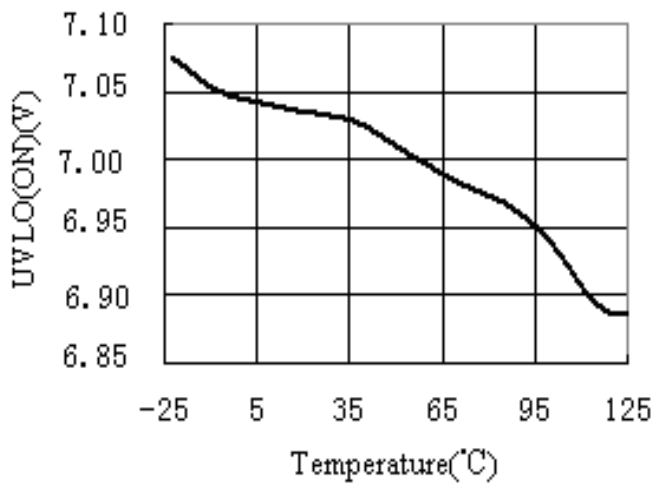
I_Vdd vs Gate load



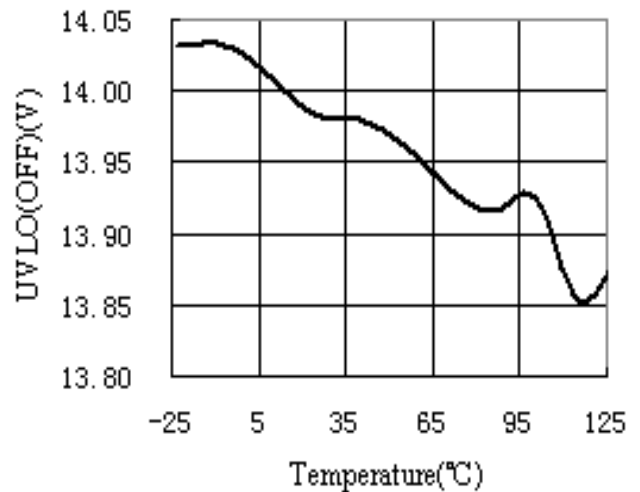
Fosc vs Temperature



UVLO(ON) vs Temperature



UVLO(OFF) vs Temperature



Function Description

WS2259 is a highly integrated current mode PWM control IC which is optimized for high performance. It is applied for switch power of the small-sized and medium-sized for example the power adaptor. The low startup current, operation current and burst mode function at the condition of no load and low load can decrease the standby power of the system, and improve the power convert efficiency. The internal synchronous slope compensation, the leading edge blanking function of the Sense pin not only decrease the component number, but also improve the stability of the system and avoid the harmonics generation. WS2259 also have multiform general recovery protection mode. The main function is described as below.

Startup Current and Startup Control

Startup current of WS2259 is designed to be very low (4uA) so that VDD could be charged up above UVLO threshold level and starts up quickly. A large value startup resistor can therefore be used to minimize the power loss, predigest the design of startup circuit and provides reliable startup in application. For the design of AC/DC adaptor with universal input range, a startup resistor of 2 MΩ, 1/8 W could be used together with a VDD capacitor to provide a fast startup and low power dissipation solution.

Operating Current

The operating current of WS2259 is very low. Good efficiency is achieved with low operating current together with extended burst mode control circuit which can easy the design of VDD capacitor.

Soft-start

As soon as VDD reaches UVLO(on), the soft-start function operates, the peak current is then gradually increased from zero. Every restart attempt is followed by 4ms soft-start.

Burst Mode

At very light load or no load condition, the IC operates in Burst Mode. In this condition, the voltage at FB is below burst mode threshold level, thus system goes into burst mode. The gate drive output switches only when VCC voltage drops below a preset level or FB input is active to output an on state. Otherwise the gate drive remains at off state to minimize the switching loss thus reduce the standby power consumption. The standby current of WS2259 is low as 800uA, Thus the standby of WS2259 can be low than 100mW. The frequency control also eliminates the audio noise at any loading conditions.

Oscillator Operation

A resistor connected between RI and GND sets the charge/discharge time of the constant current source to the internal cap and thus the PWM oscillator frequency is determined. The relationship between RI and switching frequency follows the below equation:

$$F_{osc} = \frac{6500}{RI(Kohm)} (Khz)$$

If RI floating, the frequency will be internal set at 50 KHz

Current Sensing and Leading Edge Blanking

Cycle-by-Cycle current limiting is offered in WS2259. The switch current is detected by a sense resistor into the SENSE pin. The internal Leading-edge blanking chops off the sense voltage spike at initial MOSFET on state due to snubber diode circuit reverse recovery and thus reduce the external RC filter circuit. The current limit comparator is disabled and cannot turn off the external MOSFET during the blanking period. PWM duty cycle is determined by voltage level into SENSE pin and FB pin.

Internal Synchronized Slope Compensation

Built-in slope compensation circuit adds slope voltage onto the current sense input voltage for PWM generation. This greatly improves the close loop stability at CCM and prevents the sub-harmonic oscillation and thus reduces the output ripple voltage.

Gate Driver

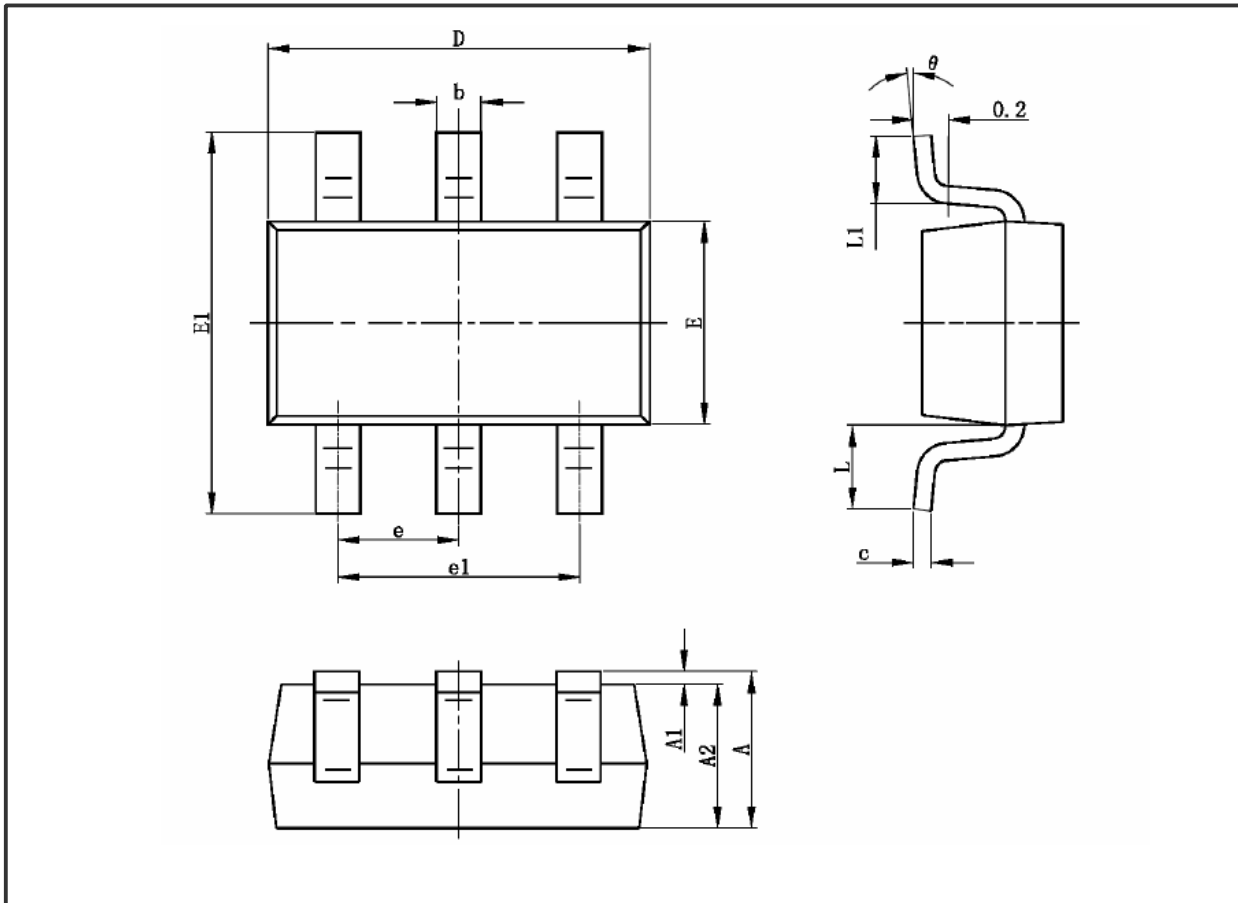
GATE pin of WS2259 is connected to the gate of an external power switch. The gate drive strength which is too weak leads to over switch loss of MOSFET while too strong gate drive output compromises in the over EMI. A good tradeoff between output strength and dead time control is achieved through the design of the built-in totem pole gate in WS2259. The low standby dissipation and good EMI system design is easier to achieve through this dedicated device. For MOSFET gate protection, an internal 13V clamp is added at higher than expected VCC input.

Protection Controls

Good power supply system reliability is achieved with auto-recovery protection features including Cycle-by-Cycle current limiting (OCP), Over Load Protection (OLP), Under Voltage Lockout on VDD (UVLO), Over Temperature Protection (OTP), and VDD Over Voltage Protection & VDD clamp.

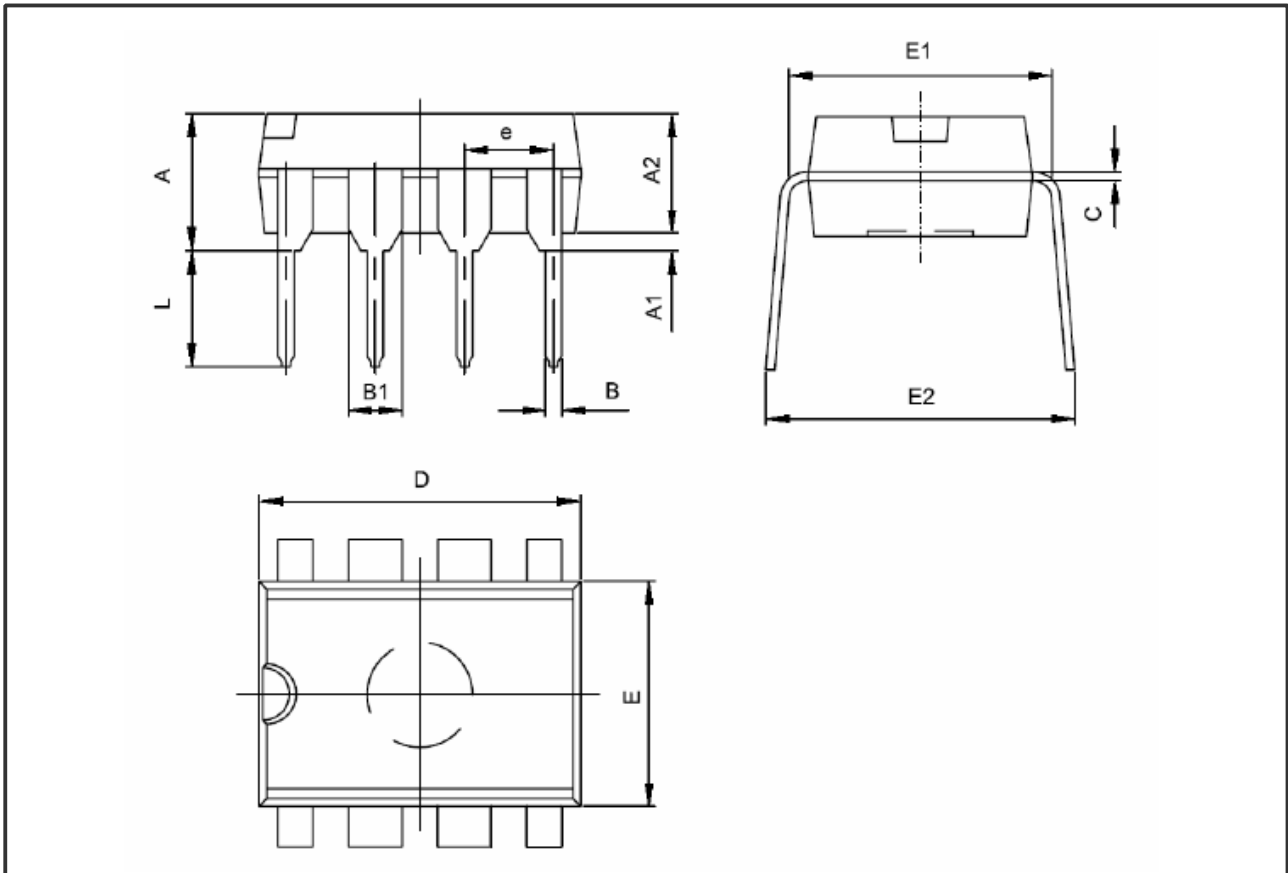
Internal line voltage compensation of OCP help to achieve constant output power limit over the universal input voltage range.

SOT23-6 Package Dimension



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 1.050 | 1.250 | 0.041 | 0.049 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 1.050 | 1.150 | 0.041 | 0.045 |
| b | 0.300 | 0.400 | 0.012 | 0.016 |
| c | 0.100 | 0.200 | 0.004 | 0.008 |
| D | 2.820 | 3.020 | 0.111 | 0.119 |
| E | 1.500 | 1.700 | 0.059 | 0.067 |
| E1 | 2.650 | 2.950 | 0.104 | 0.116 |
| e | 0.950TYP | | 0.037TYP | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 |
| L | 0.700REF | | 0.028REF | |
| L1 | 0.300 | 0.600 | 0.012 | 0.024 |
| θ | 0° | 8° | 0° | 8° |

DIP-8 Package Dimension



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 3.710 | 4.310 | 0.146 | 0.170 |
| A1 | 0.510 | | 0.020 | |
| A2 | 3.200 | 3.600 | 0.126 | 0.142 |
| B | 0.360 | 0.560 | 0.014 | 0.022 |
| B1 | 1.524(TYP) | | 0.060(TYP) | |
| C | 0.204 | 0.360 | 0.008 | 0.014 |
| D | 9.000 | 9.400 | 0.354 | 0.370 |
| E | 6.200 | 6.600 | 0.244 | 0.260 |
| E1 | 7.620(TYP) | | 0.300(TYP) | |
| e | 2.540(TYP) | | 0.100(TYP) | |
| L | 3.000 | 3.600 | 0.118 | 0.142 |
| E2 | 8.200 | 9.400 | 0.323 | 0.370 |

SOP-8 Package Dimension

Unit: mm

